



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#9/LTR fo
DRAFTSman
R. Tysor
2/16/01

In re the Application of

Chen et al

(attorney docket: TIS-25912)

Serial No. 09/115,444

Group Art Unit: 2841

Filed: July 14, 1998

Examiner: Foster, D.

For: High Density Internal Ball Grid Array Integrated Circuit Package

REQUEST FOR APPROVAL TO AMEND DRAWINGS

Commissioner for Patents

Washington, DC 20231

Dear Sir:

Approval to amend the drawings of the above-referenced application as shown in red in the attached drawing is respectfully requested.

In the drawings:

In Figure 2, add a second line identifier from reference numeral "70" to the lower cross-hatched horizontally extending member as shown in red in the attached.

REMARKS

Approval to amend the drawings in the above-referenced application is respectfully requested, and is submitted in response to a request by the Examiner to correct the drawings as follows. Specifically, the originally-filed Figure 2 illustrates a printed circuit board 70. However, the line identifier from reference numeral "70" is directed only to the upper cross-hatched horizontally extending member. The Specification states, at page 14, lines 4-5:

The printed circuit board 70 depicted has two layers, a top layer 76 and a bottom layer 78.

In view of this statement, the Examiner has objected to Figure 2 because the reference line is "drawn to only [the] top portion of the" printed circuit board. Accordingly, the proposed amendment also draws a reference line to the bottom portion of the printed circuit board.

Approval to so amend the drawings is respectfully requested.

Respectfully submitted,



Stephen L. Levine
Registry No. 33,413
Attorney for Applicant

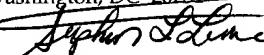
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CERTIFICATE OF MAILING
37 C.F.R. § 1.8

The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:

Commissioner for Patents
Washington, DC 20231

on January 16, 2002



Stephen L. Levine
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